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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	42
Number of Logic Elements/Cells	336
Total RAM Bits	-
Number of I/O	120
Number of Gates	4000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	160-BQFP
Supplier Device Package	160-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf8452aqc160-4

JTAG BST circuitry	Yes	No	Yes	Yes	No	Yes

...and More Features

- Peripheral register for fast setup and clock-to-output delay
- Fabricated on an advanced SRAM process
- Available in a variety of packages with 84 to 304 pins (see Table 2)
- Software design support and automatic place-and-route provided by the Altera® MAX+PLUS® II development system for Windows-based PCs, as well as Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations
- Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and Veribest

Table 2. FLEX 8000 Package Options & I/O Pin Count *Note (1)*

Device	84-Pin PLCC	100-Pin TQFP	144-Pin TQFP	160-Pin PQFP	160-Pin PGA	192-Pin PGA	208-Pin PQFP	225-Pin BGA	232-Pin PGA	240-Pin PQFP	280-Pin PGA	304-Pin RQFP
EPF8282A	68	78										
EPF8282AV		78										
EPF8452A	68	68		120	120							
EPF8636A	68			118		136	136					
EPF8820A			112	120		152	152	152				
EPF81188A							148		184	184		
EPF81500A										181	208	208

Note:
(1) FLEX 8000 device package types include plastic J-lead chip carrier (PLCC), thin quad flat pack (TQFP), plastic quad flat pack (PQFP), power quad flat pack (RQFP), ball-grid array (BGA), and pin-grid array (PGA) packages.

General Description

Altera's Flexible Logic Element MatriX (FLEX®) family combines the benefits of both erasable programmable logic devices (EPLDs) and field-programmable gate arrays (FPGAs). The FLEX 8000 device family is ideal for a variety of applications because it combines the fine-grained architecture and high register count characteristics of FPGAs with the high speed and predictable interconnect delays of EPLDs. Logic is implemented in LEs that include compact 4-input look-up tables (LUTs) and programmable registers. High performance is provided by a fast, continuous network of routing resources.

FLEX 8000 devices contain an optimized microprocessor interface that permits the microprocessor to configure FLEX 8000 devices serially, in parallel, synchronously, or asynchronously. The interface also enables the microprocessor to treat a FLEX 8000 device as memory and configure the device by writing to a virtual memory location, making it very easy for the designer to create configuration software.

The FLEX 8000 family is supported by Altera's MAX+PLUS II development system, a single, integrated package that offers schematic, text—including the Altera Hardware Description Language (AHDL), VHDL, and Verilog HDL—and waveform design entry, compilation and logic synthesis, simulation and timing analysis, and device programming. The MAX+PLUS II software provides EDIF 2 0 0 and 3 0 0, library of parameterized modules (LPM), VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX workstation-based EDA tools. The MAX+PLUS II software runs on Windows-based PCs and Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations.

The MAX+PLUS II software interfaces easily with common gate array EDA tools for synthesis and simulation. For example, the MAX+PLUS II software can generate Verilog HDL files for simulation with tools such as Cadence Verilog-XL. Additionally, the MAX+PLUS II software contains EDA libraries that use device-specific features such as carry chains, which are used for fast counter and arithmetic functions. For instance, the Synopsys Design Compiler library supplied with the MAX+PLUS II development system includes DesignWare functions that are optimized for the FLEX 8000 architecture.

For more information on the MAX+PLUS II software, go to the *MAX+PLUS II Programmable Logic Development System & Software Data Sheet*.

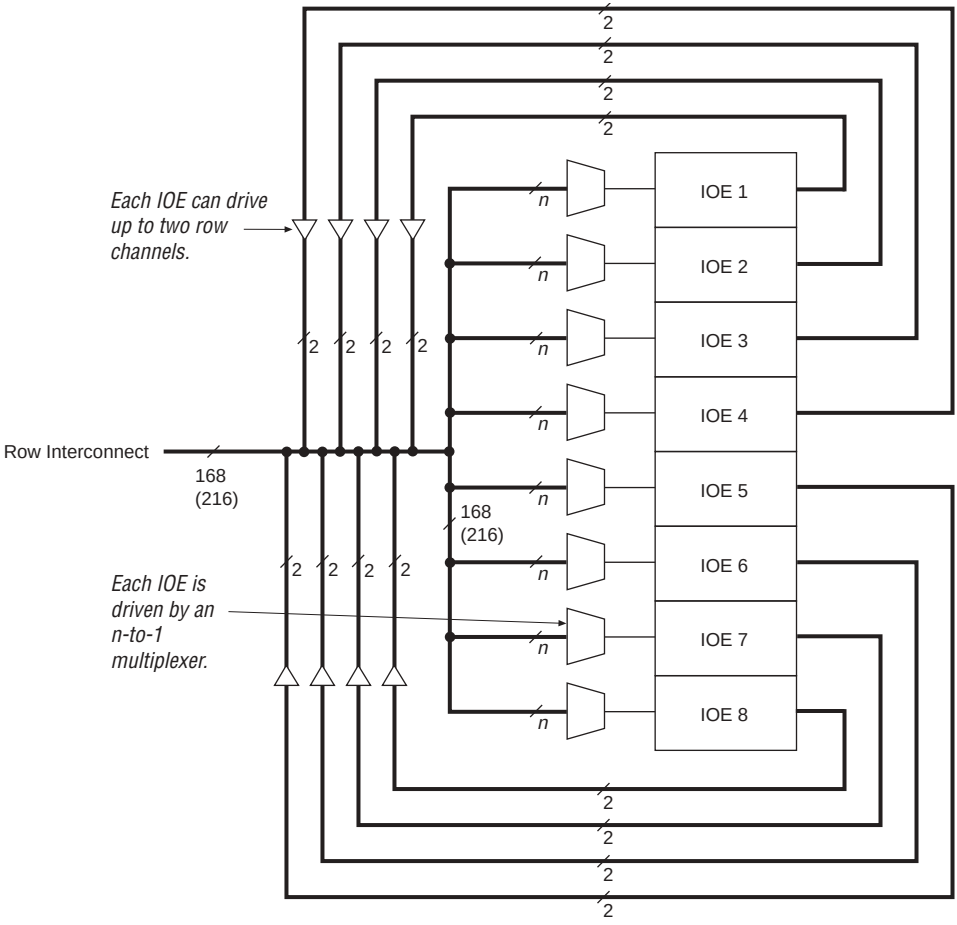
Functional Description

The FLEX 8000 architecture incorporates a large matrix of compact building blocks called logic elements (LEs). Each LE contains a 4-input LUT that provides combinatorial logic capability and a programmable register that offers sequential logic capability. The fine-grained structure of the LE provides highly efficient logic implementation.

Eight LEs are grouped together to form a logic array block (LAB). Each FLEX 8000 LAB is an independent structure with common inputs, interconnections, and control signals. The LAB architecture provides a coarse-grained structure for high device performance and easy routing.

Figure 11. FLEX 8000 Row-to-IOE Connections

Numbers in parentheses are for EPF81500A devices. See Note (1).



Note:

(1) n = 13 for EPF8282A and EPF8282AV devices.
n = 21 for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
n = 27 for EPF81500A devices.

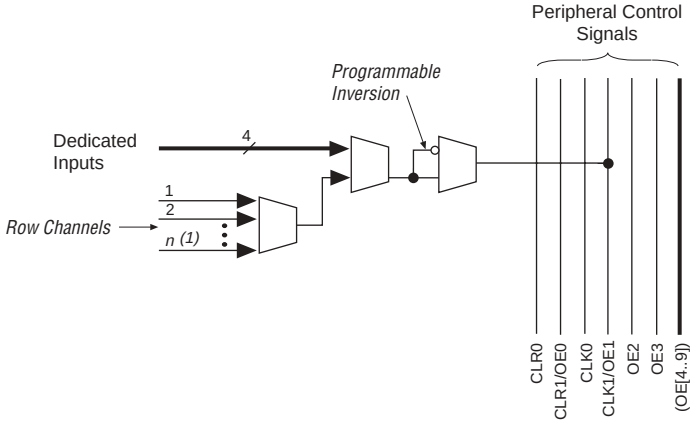
Column-to-IOE Connections

Two IOEs are located at the top and bottom of the column channels (see Figure 12). When an IOE is used as an input, it can drive up to two separate column channels. The output signal to an IOE can choose from 8 of the 16 column channels through an 8-to-1 multiplexer.

The signals for the peripheral bus can be generated by any of the four dedicated inputs or signals on the row interconnect channels, as shown in Figure 13. The number of row channels in a row that can drive the peripheral bus correlates to the number of columns in the FLEX 8000 device. EPF8282A and EPF8282AV devices use 13 channels; EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices use 21 channels; and EPF81500A devices use 27 channels. The first LE in each LAB is the source of the row channel signal. The six peripheral control signals (12 in EPF81500A devices) can be accessed by each IOE.

Figure 13. FLEX 8000 Peripheral Bus

Numbers in parentheses are for EPF81500A devices.



Note:

(1) n = 13 for EPF8282A and EPF8282AV devices.
n = 21 for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
n = 27 for EPF81500A devices.

Table 5 lists the source of the peripheral control signal for each FLEX 8000 device by row.

Table 5. Row Sources of FLEX 8000 Peripheral Control Signals

Peripheral Control Signal	EPF8282A EPF8282AV	EPF8452A	EPF8636A	EPF8820A	EPF81188A	EPF81500A
CLK0	Row A	Row A	Row A	Row A	Row E	Row E
CLK1/OE1	Row B	Row B	Row C	Row C	Row B	Row B
CLR0	Row A	Row A	Row B	Row B	Row F	Row F
CLR1/OE0	Row B	Row B	Row C	Row D	Row C	Row C
OE2	Row A	Row A	Row A	Row A	Row D	Row A
OE3	Row B	Row B	Row B	Row B	Row A	Row A
OE4	–	–	–	–	–	Row B
OE5	–	–	–	–	–	Row C
OE6	–	–	–	–	–	Row D
OE7	–	–	–	–	–	Row D
OE8	–	–	–	–	–	Row E
OE9	–	–	–	–	–	Row F

Output Configuration

This section discusses slew-rate control and MultiVolt I/O interface operation for FLEX 8000 devices.

Slew-Rate Control

The output buffer in each IOE has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A slow slew rate reduces system noise by slowing signal transitions, adding a maximum delay of 3.5 ns. The slow slew-rate setting affects only the falling edge of a signal. The fast slew rate should be used for speed-critical outputs in systems that are adequately protected against noise. Designers can specify the slew rate on a pin-by-pin basis during design entry or assign a default slew rate to all pins on a global basis.

For more information on high-speed system design, go to *Application Note 75 (High-Speed Board Designs)*.

The instruction register length for FLEX 8000 devices is three bits. Table 7 shows the boundary-scan register length for FLEX 8000 devices.

Table 7. FLEX 8000 Boundary-Scan Register Length

Device	Boundary-Scan Register Length
EPF8282A, EPF8282AV	273
EPF8636A	417
EPF8820A	465
EPF81500A	645

FLEX 8000 devices that support JTAG include weak pull-ups on the JTAG pins. Figure 14 shows the timing requirements for the JTAG signals.

Figure 14. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Waveforms

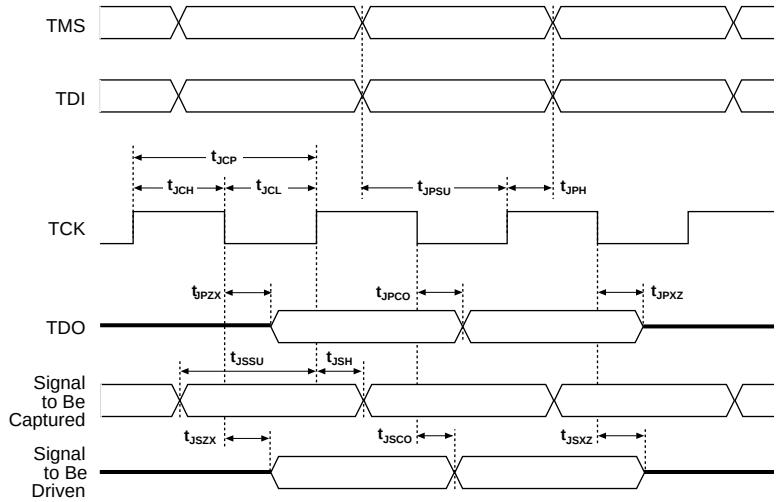
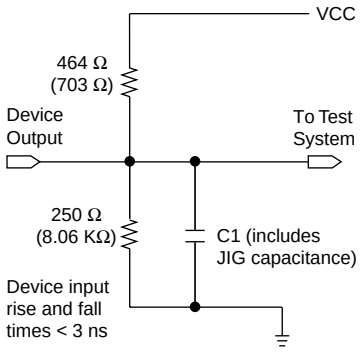


Table 8 shows the timing parameters and values for EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices.

Figure 15. FLEX 8000 AC Test Conditions

Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions. Large-amplitude, fast-ground-current transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers in parentheses are for 3.3-V devices or outputs. Numbers without parentheses are for 5.0-V devices or outputs.



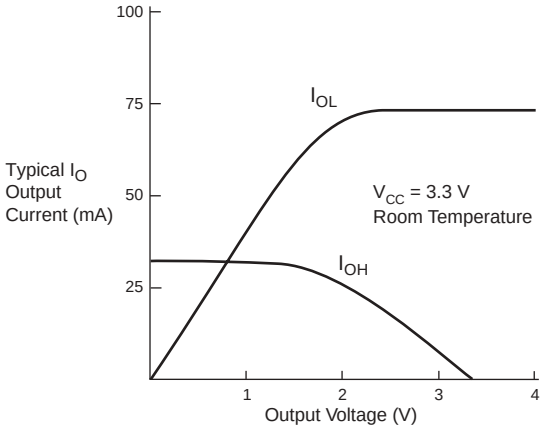
Operating Conditions

Tables 9 through 12 provide information on absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for 5.0-V FLEX 8000 devices.

Table 9. FLEX 8000 5.0-V Device Absolute Maximum Ratings *Note (1)*

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	Supply voltage	With respect to ground *(2)*	–2.0	7.0	V
V_I	DC input voltage		–2.0	7.0	V
I_{OUT}	DC output current, per pin		–25	25	mA
T_{STG}	Storage temperature	No bias	–65	150	° C
T_{AMB}	Ambient temperature	Under bias	–65	135	° C
T_J	Junction temperature	Ceramic packages, under bias		150	° C
		PQFP and RQFP, under bias		135	° C

Figure 18. Output Drive Characteristics of EPF8282AV Devices



Timing Model

The continuous, high-performance FastTrack Interconnect routing structure ensures predictable performance and accurate simulation and timing analysis. This predictable performance contrasts with that of FPGAs, which use a segmented connection scheme and hence have unpredictable performance. Timing simulation and delay prediction are available with the MAX+PLUS II Simulator and Timing Analyzer, or with industry-standard EDA tools. The Simulator offers both pre-synthesis functional simulation to evaluate logic design accuracy and post-synthesis timing simulation with 0.1-ns resolution. The Timing Analyzer provides point-to-point timing delay information, setup and hold time prediction, and device-wide performance analysis.

Tables 17 through 20 describe the FLEX 8000 timing parameters and their symbols.

Table 17. FLEX 8000 Internal Timing Parameters *Note (1)*	
Symbol	**Parameter**
t_{IOD}	IOE register data delay
t_{IOC}	IOE register control signal delay
t_{IOE}	Output enable delay
t_{IOCO}	IOE register clock-to-output delay
t_{IOCOMB}	IOE combinatorial delay
t_{IOSU}	IOE register setup time before clock; IOE register recovery time after asynchronous clear
t_{IOH}	IOE register hold time after clock
t_{IOCLR}	IOE register clear delay
t_{IN}	Input pad and buffer delay
t_{OD1}	Output buffer and pad delay, slow slew rate = off, V_{CCIO} = 5.0 V C1 = 35 pF *(2)*
t_{OD2}	Output buffer and pad delay, slow slew rate = off, V_{CCIO} = 3.3 V C1 = 35 pF *(2)*
t_{OD3}	Output buffer and pad delay, slow slew rate = on, C1 = 35 pF *(3)*
t_{XZ}	Output buffer disable delay, C1 = 5 pF
t_{ZX1}	Output buffer enable delay, slow slew rate = off, V_{CCIO} = 5.0 V, C1 = 35 pF *(2)*
t_{ZX2}	Output buffer enable delay, slow slew rate = off, V_{CCIO} = 3.3 V, C1 = 35 pF *(2)*
t_{ZX3}	Output buffer enable delay, slow slew rate = on, C1 = 35 pF *(3)*

Table 18. FLEX 8000 LE Timing Parameters *Note (1)*	
Symbol	**Parameter**
t_{LUT}	LUT delay for data-in
t_{CLUT}	LUT delay for carry-in
t_{RLUT}	LUT delay for LE register feedback
t_{GATE}	Cascade gate delay
t_{CASC}	Cascade chain routing delay
t_{CICO}	Carry-in to carry-out delay
t_{CGEN}	Data-in to carry-out delay
t_{CGENR}	LE register feedback to carry-out delay
t_{C}	LE register control signal delay
t_{CH}	LE register clock high time
t_{CL}	LE register clock low time
t_{CO}	LE register clock-to-output delay
t_{COMB}	Combinatorial delay
t_{SU}	LE register setup time before clock; LE register recovery time after asynchronous preset, clear, or load
t_{H}	LE register hold time after clock
t_{PRE}	LE register preset delay
t_{CLR}	LE register clear delay

Table 24. EPF8282A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.5		3.2	ns
t_{CLUT}		0.0		0.0		0.0	ns
t_{RLUT}		0.9		1.1		1.5	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.5		0.7	ns
t_{CGENR}		0.9		1.1		1.5	ns
t_{C}		1.6		2.0		2.5	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.1		1.2		ns
t_{H}	0.9		1.1		1.5		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 25. EPF8282A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{DRR}		15.8		19.8		24.8	ns
t_{ODH}	1.0		1.0		1.0		ns

Table 32. EPF8452A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.3		3.0	ns
t_{CLUT}		0.0		0.2		0.1	ns
t_{RLUT}		0.9		1.6		1.6	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.9		0.8	ns
t_{CGENR}		0.9		1.4		1.5	ns
t_{C}		1.6		1.8		2.4	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.0		1.1		ns
t_{H}	0.9		1.1		1.4		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 33. EPF8452A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{DRR}		16.0		20.0		25.0	ns
t_{ODH}	1.0		1.0		1.0		ns

Table 36. EPF8636A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.3		3.0	ns
t_{CLUT}		0.0		0.2		0.1	ns
t_{RLUT}		0.9		1.6		1.6	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.9		0.8	ns
t_{CGENR}		0.9		1.4		1.5	ns
t_{C}		1.6		1.8		2.4	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.0		1.1		ns
t_{H}	0.9		1.1		1.4		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 37. EPF8636A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{DRR}		16.0		20.0		25.0	ns
t_{ODH}	1.0		1.0		1.0		ns

Table 40. EPF8820A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.5		3.2	ns
t_{CLUT}		0.0		0.0		0.0	ns
t_{RLUT}		0.9		1.1		1.5	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.5		0.7	ns
t_{CGENR}		0.9		1.1		1.5	ns
t_{C}		1.6		2.0		2.5	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.1		1.2		ns
t_{H}	0.9		1.1		1.5		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 41. EPF8820A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{DRR}		16.0		20.0		25.0	ns
t_{ODH}	1.0		1.0		1.0		ns

Table 42. EPF81188A I/O Element Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{IOD}		0.7		0.8		0.9	ns
t_{IOC}		1.7		1.8		1.9	ns
t_{IOE}		1.7		1.8		1.9	ns
t_{IOCO}		1.0		1.0		1.0	ns
t_{IOCOMB}		0.3		0.2		0.1	ns
t_{IOSU}	1.4		1.6		1.8		ns
t_{IOH}	0.0		0.0		0.0		ns
t_{IOCLR}		1.2		1.2		1.2	ns
t_{IN}		1.5		1.6		1.7	ns
t_{OD1}		1.1		1.4		1.7	ns
t_{OD2}		1.6		1.9		2.2	ns
t_{OD3}		4.6		4.9		5.2	ns
t_{XZ}		1.4		1.6		1.8	ns
t_{ZX1}		1.4		1.6		1.8	ns
t_{ZX2}		1.9		2.1		2.3	ns
t_{ZX3}		4.9		5.1		5.3	ns

Table 43. EPF81188A Interconnect Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LABCASC}$		0.3		0.3		0.4	ns
$t_{LABCARRY}$		0.3		0.3		0.4	ns
t_{LOCAL}		0.5		0.6		0.8	ns
t_{ROW}		5.0		5.0		5.0	ns
t_{COL}		3.0		3.0		3.0	ns
t_{DIN_C}		5.0		5.0		5.5	ns
t_{DIN_D}		7.0		7.0		7.5	ns
t_{DIN_IO}		5.0		5.0		5.5	ns

Table 46. EPF81500A I/O Element Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{IOD}		0.7		0.8		0.9	ns
t_{IOC}		1.7		1.8		1.9	ns
t_{IOE}		1.7		1.8		1.9	ns
t_{IOCO}		1.0		1.0		1.0	ns
t_{IOCOMB}		0.3		0.2		0.1	ns
t_{IOSU}	1.4		1.6		1.8		ns
t_{IOH}	0.0		0.0		0.0		ns
t_{IOCLR}		1.2		1.2		1.2	ns
t_{IN}		1.5		1.6		1.7	ns
t_{OD1}		1.1		1.4		1.7	ns
t_{OD2}		1.6		1.9		2.2	ns
t_{OD3}		4.6		4.9		5.2	ns
t_{XZ}		1.4		1.6		1.8	ns
t_{ZX1}		1.4		1.6		1.8	ns
t_{ZX2}		1.9		2.1		2.3	ns
t_{ZX3}		4.9		5.1		5.3	ns

Table 47. EPF81500A Interconnect Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LABCASC}$		0.3		0.3		0.4	ns
$t_{LABCARRY}$		0.3		0.3		0.4	ns
t_{LOCAL}		0.5		0.6		0.8	ns
t_{ROW}		6.2		6.2		6.2	ns
t_{COL}		3.0		3.0		3.0	ns
t_{DIN_C}		5.0		5.0		5.5	ns
t_{DIN_D}		8.2		8.2		8.7	ns
t_{DIN_IO}		5.0		5.0		5.5	ns

Table 48. EPF81500A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.5		3.2	ns
t_{CLUT}		0.0		0.0		0.0	ns
t_{RLUT}		0.9		1.1		1.5	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.5		0.7	ns
t_{CGENR}		0.9		1.1		1.5	ns
t_{C}		1.6		2.0		2.5	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.1		1.2		ns
t_{H}	0.9		1.1		1.5		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 49. EPF81500A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{DRR}		16.1		20.1		25.1	ns
t_{ODH}	1.0		1.0		1.0		ns

Table 53. FLEX 8000 160-, 192- & 208-Pin Package Pin-Outs (Part 1 of 2)

Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A *(1)*	208-Pin PQFP EPF8820A *(1)*	208-Pin PQFP EPF81188A *(1)*
nSP *(2)*	120	1	R15	207	207	5
MSEL0 *(2)*	117	3	T15	4	4	21
MSEL1 *(2)*	84	38	T3	49	49	33
nSTATUS *(2)*	37	83	B3	108	108	124
nCONFIG *(2)*	40	81	C3	103	103	107
DCLK *(2)*	1	120	C15	158	158	154
CONF_DONE *(2)*	4	118	B15	153	153	138
nWS	30	89	C5	114	114	118
nRS	71	50	B5	66	116	121
RDCLK	73	48	C11	64	137	137
nCS	29	91	B13	116	145	142
CS	27	93	A16	118	148	144
RDYnBUSY	125	155	A8	201	127	128
CLKUSR	76	44	A10	59	134	134
ADD17	78	43	R5	57	43	46
ADD16	91	33	U3	43	42	45
ADD15	92	31	T5	41	41	44
ADD14	94	29	U4	39	40	39
ADD13	95	27	R6	37	39	37
ADD12	96	24	T6	31	35	36
ADD11	97	23	R7	30	33	31
ADD10	98	22	T7	29	31	30
ADD9	99	21	T8	28	29	29
ADD8	101	20	U9	24	25	26
ADD7	102	19	U10	23	23	25
ADD6	103	18	U11	22	21	24
ADD5	104	17	U12	21	19	18
ADD4	105	13	R12	14	14	17
ADD3	106	11	U14	12	13	16
ADD2	109	9	U15	10	11	10
ADD1	110	7	R13	8	10	9
ADD0	123	157	U16	203	9	8
DATA7	144	137	H17	178	178	177
DATA6	150	132	G17	172	176	175
DATA5	152	129	F17	169	174	172

Table 53. FLEX 8000 160-, 192- & 208-Pin Package Pin-Outs (Part 2 of 2)

Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A *(1)*	208-Pin PQFP EPF8820A *(1)*	208-Pin PQFP EPF81188A *(1)*
DATA4	154	127	E17	165	172	170
DATA3	157	124	G15	162	171	168
DATA2	159	122	F15	160	167	166
DATA1	11	115	E16	149	165	163
DATA0	12	113	C16	147	162	161
SDOUT *(3)*	128	152	C7 *(11)*	198	124	119
TDI *(4)*	–	55	R11	72	20	–
TDO *(4)*	–	95	B9	120	129	–
TCK *(4)*, *(6)*	–	57	U8	74	30	–
TMS *(4)*	–	59	U7	76	32	–
TRST *(7)*	–	40	R3	54	54	–
Dedicated Inputs *(10)*	5, 36, 85, 116	6, 35, 87, 116	A5, U5, U13, A13	7, 45, 112, 150	17, 36, 121, 140	13, 41, 116, 146
VCCINT (5.0 V)	21, 41, 53, 67, 80, 81, 100, 121, 133, 147, 160	4, 5, 26, 85, 106	C8, C9, C10, R8, R9, R10, R14	5, 6, 33, 110, 137	5, 6, 27, 48, 119, 141	4, 20, 35, 48, 50, 102, 114, 131, 147
VCCIO (5.0 V or 3.3 V)	–	25, 41, 60, 70, 80, 107, 121, 140, 149, 160	D3, D4, D9, D14, D15, G4, G14, L4, L14, P4, P9, P14	32, 55, 78, 91, 102, 138, 159, 182, 193, 206	26, 55, 69, 87, 102, 131, 159, 173, 191, 206	3, 19, 34, 49, 69, 87, 106, 123, 140, 156, 174, 192
GND	13, 14, 28, 46, 60, 75, 93, 107, 108, 126, 140, 155	15, 16, 36, 37, 45, 51, 75, 84, 86, 96, 97, 117, 126, 131, 154	C4, D7, D8, D10, D11, H4, H14, K4, K14, P7, P8, P10, P11	19, 20, 46, 47, 60, 67, 96, 109, 111, 124, 125, 151, 164, 171, 200	15, 16, 37, 38, 60, 78, 96, 109, 110, 120, 130, 142, 152, 164, 182, 200	11, 12, 27, 28, 42, 43, 60, 78, 96, 105, 115, 122, 132, 139, 148, 155, 159, 165, 183, 201
No Connect (N.C.)	2, 3, 38, 39, 70, 82, 83, 118, 119, 148	2, 39, 82, 119	C6, C12, C13, C14, E3, E15, F3, J3, J4, J14, J15, N3, N15, P3, P15, R4 *(12)*	1, 2, 3, 16, 17, 18, 25, 26, 27, 34, 35, 36, 50, 51, 52, 53, 104, 105, 106, 107, 121, 122, 123, 130, 131, 132, 139, 140, 141, 154, 155, 156, 157, 208	1, 2, 3, 50, 51, 52, 53, 104, 105, 106, 107, 154, 155, 156, 157, 208	1, 2, 51, 52, 53, 54, 103, 104, 157, 158, 207, 208
Total User I/O Pins *(9)*	116	114	132, 148 *(13)*	132	148	144

Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 1 of 3)

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
nSP *(2)*	A15	C14	237	237	W1	304
MSEL0 *(2)*	B14	G15	21	19	N1	26
MSEL1 *(2)*	R15	L15	40	38	H3	51
nSTATUS *(2)*	P2	L3	141	142	G19	178
nCONFIG *(2)*	R1	R4	117	120	B18	152
DCLK *(2)*	B2	C4	184	183	U18	230
CONF_DONE *(2)*	A1	G3	160	161	M16	204
nWS	L4	P1	133	134	F18	167
nRS	K5	N1	137	138	G18	171
RDCLK	F1	G2	158	159	M17	202
nCS	D1	E2	166	167	N16	212
CS	C1	E3	169	170	N18	215
RDYnBUSY	J3	K2	146	147	J17	183
CLKUSR	G2	H2	155	156	K19	199
ADD17	M14	R15	58	56	E3	73
ADD16	L12	T17	56	54	E2	71
ADD15	M15	P15	54	52	F4	69
ADD14	L13	M14	47	45	G1	60
ADD13	L14	M15	45	43	H2	58
ADD12	K13	M16	43	41	H1	56
ADD11	K15	K15	36	34	J3	47
ADD10	J13	K17	34	32	K3	45
ADD9	J15	J14	32	30	K4	43
ADD8	G14	J15	29	27	L1	34
ADD7	G13	H17	27	25	L2	32
ADD6	G11	H15	25	23	M1	30
ADD5	F14	F16	18	16	N2	20
ADD4	E13	F15	16	14	N3	18
ADD3	D15	F14	14	12	N4	16
ADD2	D14	D15	7	5	U1	8
ADD1	E12	B17	5	3	U2	6
ADD0	C15	C15	3	1	V1	4
DATA7	A7	A7	205	199	W13	254
DATA6	D7	D8	203	197	W14	252
DATA5	A6	B7	200	196	W15	250

Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 2 of 3)

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
DATA4	A5	C7	198	194	W16	248
DATA3	B5	D7	196	193	W17	246
DATA2	E6	B5	194	190	V16	243
DATA1	D5	A3	191	189	U16	241
DATA0	C4	A2	189	187	V17	239
SDOUT *(3)*	K1	N2	135	136	F19	169
TDI	F15 *(4)*	–	–	63 *(14)*	B1 *(14)*	80 *(14)*
TDO	J2 *(4)*	–	–	117	C17	149
TCK *(6)*	J14 *(4)*	–	–	116 *(14)*	A19 *(14)*	148 *(14)*
TMS	J12 *(4)*	–	–	64 *(14)*	C2 *(14)*	81 *(14)*
TRST *(7)*	P14	–	–	115 *(14)*	A18 *(14)*	145 *(14)*
Dedicated Inputs *(10)*	F4, L1, K12, E15	C1, C17, R1, R17	10, 51, 130, 171	8, 49, 131, 172	F1, F16, P3, P19	12, 64, 164, 217
VCCINT (5.0 V)	F5, F10, E1, L2, K4, M12, P15, H13, H14, B15, C13	E4, H4, L4, P12, L14, H14, E14, R14, U1	20, 42, 64, 66, 114, 128, 150, 172, 236	18, 40, 60, 62, 91, 114, 129, 151, 173, 209, 236	B17, D3, D15, E8, E10, E12, E14, R7, R9, R11, R13, R14, T14	24, 54, 77, 144, 79, 115, 162, 191, 218, 266, 301
VCCIO (5.0 V or 3.3 V)	H3, H2, P6, R6, P10, N10, R14, N13, H15, H12, D12, A14, B10, A10, B6, C6, A2, C3, M4, R2	N10, M13, M5, K13, K5, H13, H5, F5, E10, E8, N8, F13	19, 41, 65, 81, 99, 116, 140, 162, 186, 202, 220, 235	17, 39, 61, 78, 94, 108, 130, 152, 174, 191, 205, 221, 235	D14, E7, E9, E11, E13, R6, R8, R10, R12, T13, T15	22, 53, 78, 99, 119, 137, 163, 193, 220, 244, 262, 282, 300